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Specification							
Part Number:							
Version:							
Date:							
Revision							

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#### **1.General Specification**

The Features is described as follow:

- Module dimension: 115.0 x 36.0 x 13.9 (MAX) mm
- View area: 85.0 x 18.6 mm
- Active area: 73.5 x 11.5 mm
- Number of Characters: 20 characters x 2 Lines
- Dot size: 0.60 x 0.65 mm
- Dot pitch: 0.65 x 0.70 mm
- Character size: 3.20 x 5.55 mm
- Character pitch: 3.70 x 5.95 mm
- LCD type: VA Negative Transmissive
- Duty: 1/16
- View direction: 12 o'clock
- Backlight Type: LED, Yellow Green(High light)
- IC:ST7066U

#### Midas LCD Part Number System

MC	COG	13203	3 A	*	6	w	*	*	-	S	Ν	т	L	w	*	*
1	2	3	4	5	6	7	8	9	-	10	11	12	13	14	15	16
1	=	MC: Mid	as Compo	onents												
2	=	Blank: C	OB (chip	on boar	d) COG	chip	on glas	s								
3	=	No of dot	ts	(e.g. 24	0064 =	240 x	: 64 dot	s)	(e	.g. 216	05 = 2	x 16 5m	m C.H.	)		
4	=	Series														
5	=	Series Va	riant:	A to Z	– see ad	ldend	um									
6	=	<b>3:</b> 3 o'clo	ock	<b>6:</b> 6 o'c	lock	Ģ	): 9 o'cl	ock	12	2: 12 o'	clock					
7	=	S: Norma	al (0 to +	50 deg C	C) <b>W:</b> W	7ide t	emp. (-	20 to + 7	70 deş	gC)Xa	Exten	ded ten	np (-30 -	+ 80 De	g C)	
8	=	Characte	er Set													
		Giank: S C: Chines CB: Chin H: Hebro K: Europ L: Englis M: Europ R: Cyrill W: Europ U: Europ J: Asian/	tandard se Simpli iese Big 5 ew pean (std sh/Japan pean (En jean (En jean (En j/Arabic	(English/ fied (Graphi ) (English ese (speci glish/Sca glish/Sca	Japane phic Di c Displa h/Germ al) ndinavi eek) ndinavi	se) splay ays or an/Fr ian) an/Ic	s only) ly) ench/G elandic	reek) )								
9	=	Bezel He	eight (who	ere applio	eable / a	vaila	ble)									
			Top of	Bezel to of PCB	Тор	Cor (via ar	nmon pins 1 1d 2)	Arra or Eo Lit	ay Ige t							
		Blank	9.5mm applica	/ not ble		Cor	nmon	Arra	ay							
		2	8.9 mm			Сог	nmon	Arra	ay							
		3	7.8 mm			Sep	oarate	Arra	ay							
		4	7.8 mm			Cor	nmon	Arra	ay							
		5	9.5 mm			Sep	arate	Arra	ay							
		6	7 mm			Cor	nmon	Arra	ay							
		7	7 mm			Sep	arate	Arra	ay							
		8	6.4 mm			Сог	nmon	Edg	ge							
		9	6.4 mm			Sep	oarate	Edg	ge							
		Α	5.5 mm			Cor	nmon	Edg	ge							
		В	5.5  mm			Sep	oarate	Edg	ge							
		D	6.0mm			Sep	oarate	Edg	ge							
		Е	5.0mm			Sep	oarate	Edg	ge							
		F	4.7mm			Cor	nmon	Edg	ge							
		G	3.7mm			Sep	oarate	EI	-							
10	=	T: TN S	: STN B:	STN Blu	ue <b>G:</b> S	TN G	rey F:	FSTN I	5 <b>2:</b> F	FSTN	V: VAT	IN Z:Z	Zero Po	wer (Bi	-Stable)	)
11	=	<b>P:</b> Positi	ve N: Ne	gative												

12 = R: Reflective M: Transmissive T: Transflective

13 = Backlight: Blank: Reflective L: LED

14 = Backlight Colour: Y: Yellow-Green W: White B: Blue R: Red A: Amber O: Orange G: Green RGB: R.G.B.

If Z (Zero Power): WB: White on blue GB: Green on black YB: Yellow on black YPB: Yellow on pink and/or blue

15 = Driver Chip: Blank: Standard I: I<sup>2</sup>C T: Toshiba T6963C A: Avant SAP1024B R: Raio RA8835

16 = Voltage Variant: e.g. 3 = 3v

## **3.Interface Pin Function**

Pin No.	Symbol	Level	Description
1	$V_{SS}$	0V	Ground
2	$V_{DD}$	5.0V	Supply Voltage for logic
3	VO	(Variable)	Operating voltage for LCD
4	RS	H/L	H: DATA, L: Instruction code
5	R/W	H/L	H: Read (Module> MPU) L: Write(MPU> Module)
6	Е	H,H→L	Chip enable signal
7	DB0	H/L	Data bus line
8	DB1	H/L	Data bus line
9	DB2	H/L	Data bus line
10	DB3	H/L	Data bus line
11	DB4	H/L	Data bus line
12	DB5	H/L	Data bus line
13	DB6	H/L	Data bus line
14	DB7	H/L	Data bus line
15	Vee	_	Negative Voltage Output
16	К	_	Power supply for B/L -

#### 4.Contour Drawing & Block Diagram









The non-specified tolerance of dimension is  $\pm 0.3$ mm.



## **5.Character Generator ROM Pattern**

Table.2

Upper 4 bit Lower 4 bit	LLLL	LLLH	LLHL	LLHH	LHLL	LHLH	LHHL	LHHH	HLLL	HLLH	HLHL	HLHH	HHLL	HHLH	HHHL	нннн
LLLL	CG RAM (1)						••						.]	₩.	Ċ.	<b>¦∷</b> ı
LLLH	(2)							-::					Ţ.	ć.,	-	<b>ا</b> ا
LLHL	(3)		11					ŀ".			1	·	Uļ	.:: <b>'</b>	l≣:	I <u></u>
LLHH	(4)		÷			:;	: <u></u> .	·				ŗ	Ţ	1	:	a:-:*
LHLL	(5)		:	:: <b>[</b> .				1			•.		ŀ	1::	·I	::"i
LHLH	(6)							I]					<b>!</b>		1.15	II
LHHL	(7)		8.	<b>E</b>		l.,I	Ŧ.	ا. ا				17	•••		l:∷ı	<b>.</b>
LННН	(8)		3	:			·	II				÷			<b>ا</b> ا	:FT:
HLLL	(1)		Ć			2	ŀ"ı	343			۰i,	-]]		Ļ	. <b>I</b> ''	
HLLH	(2)		)		1	ا. ۲	1	<b>!</b> !			-:::	ŗ		11	1	ا <u></u> ا
HLHL	(3)		:-[+:	:: ::										<u>.</u>	<u> </u>	=p:
нгнн	(4)			:: ::	Þ:		l::	÷			;:• ·	<b>!!</b>	<u> </u>		:-:	]#i
HHLL	(5)		:	-	l		1				177	Ë.I		<u> </u>	·: <b> </b> :-	: ::
HHLH	(6)						ľ•'i	}					••••		₽	<b>i</b>
HHHL	(7)				ŀ··	••••	ŀ"ı					12	•• <b> </b> ••	•••	l <sup>:=</sup> I	
нннн	(8)			•			<u> </u>	- <b>!</b>			• :.•	<b>!</b> !	·.:	<b>I</b> .I	ı <u></u> ı	

#### **6.Optical Characteristics**

ltem	Symbol	Condition	Min	Тур	Max	Unit
	θ	CR≧10	_	60	_	ψ= 180°
View Angle	θ	CR≧10	_	25	_	ψ= 0°
	θ	CR≧10	_	40	_	ψ= 90°
	θ	CR≧10	_	40	_	ψ= 270°
Contrast Ratio	CR	_	10	_	_	_
	T rise	_	_	300	350	ms
Response Time	T fall	_		300	350	ms

#### **Definition of Operation Voltage (Vop)**







#### **Conditions :**

Operating Voltage : Vop

Viewing Angle( $\theta$ ,  $\phi$ ) : 0°, 0°

Frame Frequency : 64 HZ Driving Waveform : 1/N duty , 1/a bias

#### Definition of viewing angle(CR≥2)



# 7.Absolute Maximum Ratings

ltem	Symbol	Min	Тур	Мах	Unit
Operating Temperature	T <sub>OP</sub>	-20	_	+70	
Storage Temperature	T <sub>ST</sub>	-30	_	+80	
Input Voltage	VI	V <sub>SS</sub>	_	V <sub>DD</sub>	V
Supply Voltage For Logic	VDD-V <sub>SS</sub>	-0.3	_	7	V
Supply Voltage For LCD	V <sub>DD</sub> -V <sub>o</sub>	-0.3	_	13	V

## **8.Electrical Characteristics**

ltem	Symbol	Condition	Min	Тур	Max	Unit
Supply Voltage For Logic	$V_{DD}$ - $V_{SS}$	_	4.5	5.0	5.5	V
Supply Voltage For LCD		Ta=-20	_	_	_	V
*Note	$V_{DD}$ - $V_0$	Ta=25	8.2	8.5	8.8	V
		Ta=70	_	—	_	V
Input High Volt.	V <sub>IH</sub>	_	$0.7 V_{DD}$	_	V <sub>DD</sub>	V
Input Low Volt.	V <sub>IL</sub>	_	Vss	_	0.6	V
Output High Volt.	V <sub>OH</sub>	_	3.9		Vdd	V
Output Low Volt.	V <sub>OL</sub>	_	0	_	0.4	V
Supply Current	I <sub>DD</sub>	V <sub>DD</sub> =5.0V	_	2.4	_	mA

\*Note: Please design the VOP adjustment circuit on customer's main board



## 9.Backlight Information

#### Specification

PARAMETER	SYMBOL	MIN	ТҮР	MAX	UNIT	TEST CONDITION		
Supply Current	ILED	_	48	60	mA	V=5.0V		
Supply Voltage	V	4.9	5.0	5.1	v	_		
Reverse Voltage	VR	_	_	5	v	_		
Luminance (Without LCD)	IV	560	700	_	CD/M <sup>2</sup>	ILED=48mA		
Wave Length	Λр	567	570	575	nm	ILED=48mA		
LED Life Time (For Reference only)	_	_	50K	_	Hr.	ILED=48mA 25 ,50-60%RH, (Note 1)		
Color	Yellow Gre	ellow Green (high light)						

Note: The LED of B/L is drive by current only, drive voltage is for reference only. drive voltage can make driving current under safety area (current between minimum and maximum).

Drive from Vdd , Pin 16



## 10.Reliability

#### Content of Reliability Test (Wide temperature, -20 ~70 )

Environmental Test									
Test Item	Content of Test	Test Condition	Note						
High Temperature storage	Endurance test applying the high storage temperature for a long time.	80 200hrs	2						
Low Temperature storage	Endurance test applying the low storage temperature for a long time.	-30 200hrs	1,2						
High Temperature Operation	Endurance test applying the electric stress (Voltage & Current) and the thermal stress to the element for a long time.	70 200hrs							
Low Temperature Operation	Endurance test applying the electric stress under low temperature for a long time.	-20 200hrs	1						
High Temperature/ Humidity storage	The module should be allowed to stand at 60 ,90%RH max For 96hrs under no-load condition excluding the polarizer, Then taking it out and drying it at normal temperature.	60 ,90%RH 96hrs	1,2						
Thermal shock resistance	The sample should be allowed stand the following 10 cycles of operation -20 25 70	-20 /70 10 cycles							
Vibration test	Endurance test applying the vibration during transportation and using.	Total fixed amplitude : 1.5mm Vibration Frequency : 10~55Hz One cycle 60 seconds to 3 directions of X,Y,Z for Each 15 minutes	3						
Static electricity test	Endurance test applying the electric stress to the terminal.	VS=800V,RS=1.5kΩ CS=100pF 1 time							

Note1: No dew condensation to be observed.

Note2: The function test shall be conducted after 4 hours storage at the normal

Temperature and humidity after remove from the test chamber.

Note3: The packing have to including into the vibration testing.

# **11.Inspection specification**

NO	Item			Criterion		AQL		
01	Electrical Testing	<ol> <li>1.1 Missing vert defect.</li> <li>1.2 Missing chan</li> <li>1.3 Display malf</li> <li>1.4 No function</li> <li>1.5 Current cons</li> <li>1.6 LCD viewing</li> <li>1.7 Mixed produ</li> <li>1.8 Contrast def</li> </ol>	<ul> <li>defect.</li> <li>1.2 Missing character , dot or icon.</li> <li>1.3 Display malfunction.</li> <li>1.4 No function or no display.</li> <li>1.5 Current consumption exceeds product specifications.</li> <li>1.6 LCD viewing angle defect.</li> <li>1.7 Mixed product types.</li> <li>1.8 Contrast defect.</li> </ul>					
02	Black or white spots on LCD	2.1 White and b three white c	lack spots or black sp	s on display $\leq$ 0.25 bots present.	mm, no more than	2.5		
	(display only)	2.2 Densely spa	aced: No r	nore than two spot	s or lines within 3mm			
03	LCD black spots, white spots, contamination (non-display)	3.1 Round type $\Phi = (x + y) / $ $\downarrow$	: As follov 2 ↓ Y As followin Length  L≦3.0 L≦2.5 	SIZE $\Phi \le 0.10$ $0.10 < \Phi \le 0.20$ $0.20 < \Phi \le 0.25$ $0.25 < \Phi$ width $W \le 0.02$ $0.02 < W \le 0.03$ $0.03 < W \le 0.05$ $0.05 < W$	Acceptable Q TY Accept no dense 2 1 0 Acceptable Q TY Accept no dense 2 As round type	2.5		
04	Polarizer bubbles	If bubbles are vi judge using blac specifications, n to find, must che specify direction	sible, ck spot iot easy eck in i.	Size $\Phi$ $\Phi \le 0.20$ $0.20 < \Phi \le 0.50$ $0.50 < \Phi \le 1.00$ $1.00 < \Phi$ Total Q TY	Acceptable Q TY Accept no dense 3 2 0 3 3	2.5		

NO	Item		Criterion						
05	Scratches	Follow NO.3 LCD black	spots, white spots, con	tamination					
		Symbols Define: x: Chip length y: 0 k: Seal width t: 0 L: Electrode pad length	Chip width z: Chip t Glass thickness a: LCE :	hickness 9 side length					
	5.1 General glass chip : 5.1.1 Chip on panel surface and crack between panels:								
		z: Chip thickness	y: Chip width	x: Chip length					
06	Chipped	Z≦1/2t	Not over viewing area	x≦1/8a	25				
00	glass	$1/2t < z \leq 2t$	Not exceed 1/3k	x≦1/8a	2.0				
		<ul> <li>⊙ If there are 2 or more</li> <li>6.1.2 Corner crack:</li> <li>z: Chip thickness</li> <li>z &lt; 1/2t</li> </ul>	chips, x is total length of	f each chip. <b>y</b> x: Chip length x≤1/8a					
		∠ <u>⇒</u> 1/∠l	area	∧ <u>⇒</u> πσα					
		$1/2t < z \leq 2t$	Not exceed 1/3k	x≦1/8a					
		$\odot$ If there are 2 or more	chips, x is the total leng	th of each chip.					



NO	Item	Criterion	AQL
07	Cracked glass	The LCD with extensive crack is not acceptable.	2.5
08	Backlight elements	<ul> <li>8.1 Illumination source flickers when lit.</li> <li>8.2 Spots or scratched that appear when lit must be judged. Using LCD spot, lines and contamination standards.</li> <li>8.3 Backlight doesn't light or color wrong.</li> </ul>	0.65 2.5 0.65
09	Bezel	<ul><li>9.1 Bezel may not have rust, be deformed or have fingerprints, stains or other contamination.</li><li>9.2 Bezel must comply with job specifications.</li></ul>	2.5 0.65
10	PCB \ COB	<ul> <li>10.1 COB seal may not have pinholes larger than 0.2mm or contamination.</li> <li>10.2 COB seal surface may not have pinholes through to the IC.</li> <li>10.3 The height of the COB should not exceed the height indicated in the assembly diagram.</li> <li>10.4 There may not be more than 2mm of sealant outside the seal area on the PCB. And there should be no more than three places.</li> <li>10.5 No oxidation or contamination PCB terminals.</li> <li>10.6 Parts on PCB must be the same as on the production characteristic chart. There should be no wrong parts, missing parts or excess parts.</li> <li>10.7 The jumper on the PCB should conform to the product characteristic chart.</li> <li>10.8 If solder gets on bezel tab pads, LED pad, zebra pad or screw hold pad, make sure it is smoothed down.</li> <li>10.9 The Scraping testing standard for Copper Coating of PCB</li> </ul>	<ol> <li>2.5</li> <li>2.5</li> <li>0.65</li> <li>2.5</li> <li>0.65</li> <li>0.65</li> <li>2.5</li> <li>2.5</li> <li>2.5</li> <li>2.5</li> </ol>
11	Soldering	<ul> <li>11.1 No un-melted solder paste may be present on the PCB.</li> <li>11.2 No cold solder joints, missing solder connections, oxidation or icicle.</li> <li>11.3 No residue or solder balls on PCB.</li> <li>11.4 No short circuits in components on PCB.</li> </ul>	<ol> <li>2.5</li> <li>2.5</li> <li>2.5</li> <li>0.65</li> </ol>

NO	Item	Criterion			
NO 12	Item General appearance	Criterion 12.1 No oxidation, contamination, curves or, bends on interface Pin (OLB) of TCP. 12.2 No cracks on interface pin (OLB) of TCP. 12.3 No contamination, solder residue or solder balls on product. 12.4 The IC on the TCP may not be damaged, circuits. 12.5 The uppermost edge of the protective strip on the interface pin must be present or look as if it cause the interface pin to sever. 12.6 The residual rosin or tin oil of soldering (component or chip component) is not burned into brown or black color. 12.7 Sealant on top of the ITO circuit has not hardened. 12.8 Pin type must match type in specification sheet.	AQL 2.5 0.65 2.5 2.5 2.5 2.5 2.5 2.5 0.65 0.65		
		12.8 Pin type must match type in specification sheet. 12.9 LCD pin loose or missing pins.	0.65 0.65		
		12.9 LCD pin loose or missing pins. 12.10 Product packaging must the same as specified on			
		12.11 Product dimension and structure must conform to product specification sheet.	0.65		
		12.12 Visual defect outside of VA is not considered to be rejection.			

### 12.Precautions in use of LCD Modules

- (1)Avoid applying excessive shocks to the module or making any alterations or modifications to it.
- (2)Don't make extra holes on the printed circuit board, modify its shape or change the components of LCD module.
- (3)Don't disassemble the LCM.
- (4)Don't operate it above the absolute maximum rating.
- (5)Don't drop, bend or twist LCM.
- (6)Soldering: only to the I/O terminals.
- (7)Storage: please storage in anti-static electricity container and clean environment.
- (8) Midas have the right to change the passive components, including R3,R6 & backlight adjust resistors. (Resistors,capacitors and other passive components will have different appearance and color caused by the different supplier.)
- (9)Midas have the right to change the PCB Rev. (In order to satisfy the supplying stability, management optimization and the best product performance...etc, under the premise of not affecting the electrical characteristics and external dimensions, Midas have the right to modify the version.)

## **13.Material List of Components for RoHs**

 Midas Display Co., Ltd hereby declares that all of or part of products (with the mark "#"in code), including, but not limited to, the LCM, accessories or packages, manufactured and/or delivered to your company (including your subsidiaries and affiliated company) directly or indirectly by our company (including our subsidiaries or affiliated companies) do not intentionally contain any of the substances listed in all applicable EU directives and regulations, including the following substances.

Exhibit A : The Harmful Material List

Material	(Cd)	(Pb)	(Hg)	(Cr6+)	PBBs	PBDEs			
Limited Value	100 ppm	1000 ppm	1000 ppm	1000 ppm	1000 ppm	1000 ppm			
Above limited value is set up according to RoHS.									

2.Process for RoHS requirement :

- (1) Use the Sn/Ag/Cu soldering surface ; the surface of Pb-free solder is rougher than we used before.
- (2) Heat-resistance temp. :

Reflow: 250 ,30 seconds Max.;

Connector soldering wave or hand soldering : 320  $\,$  , 10 seconds max.

(3) Temp. curve of reflow, max. Temp. : 235±5 ;

Recommended customer's soldering temp. of connector : 280 , 3 seconds.

## 14.Recommendable Storage

- 1. Place the panel or module in the temperature 25°C±5°C and the humidity below 65% RH
- 2. Do not place the module near organics solvents or corrosive gases.
- 3. Do not crush, shake, or jolt the module.

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